

## Features

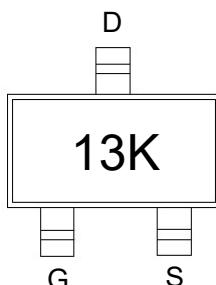
- Trench Power LV MOSFET technology
- High Density Cell Design for Low  $R_{DS(ON)}$
- High Speed switching

## Product Summary

$V_{DS}$	$R_{DS(ON)} \text{ MAX}$	$I_D \text{ MAX}$
-20V	113mΩ@-10V	-1.4A
	135mΩ@-4.5V	

## Application

- Battery protection
- Load switch
- Power management

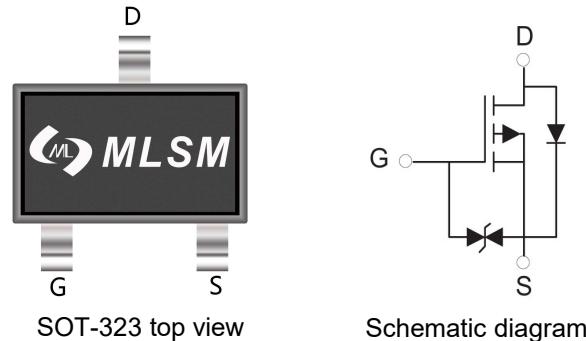


13K: Device code

Marking and pin assignment



SOT-323 top view



Schematic diagram



Halogen-Free

## Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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## Common Ratings (TC=25°C Unless Otherwise Noted)

$V_{DS}$	Drain-Source Breakdown Voltage	-20	V
$V_{GS}$	Gate-Source Voltage	±12	V
$T_J$	Maximum Junction Temperature	150	°C
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$I_S$	Diode Continuous Forward Current	Tc=25°C -1.4	A

## Mounted on Large Heat Sink

$I_{DM}$	Pulse Drain Current Tested	Tc=25°C -13	A
$I_D$	Continuous Drain Current	Tc=25°C -1.4	A
$P_D$	Maximum Power Dissipation	Tc=25°C 0.35	W
$R_{θJA}$	Thermal Resistance Junction-to-Ambient	350	°C/W

## Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MLS7413KW	SOT-323	13K	3,000	45,000	180,000	7" reel

**Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)</b>						
BV <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA	-20	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V	--	--	-1	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V	--	--	±10	uA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-0.5	-0.7	-1.2	V
R <sub>DS(on)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =-10V, I <sub>D</sub> =-1.4A	--	94	113	mΩ
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-1.3A	--	111	135	mΩ

**Dynamic Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)**

C <sub>ISS</sub>	Input Capacitance	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1MHz	--	510	--	pF
C <sub>OSS</sub>	Output Capacitance		--	55	--	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance		--	16	--	pF

**Switching Characteristics**

Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =-9V, I <sub>D</sub> =-1A, V <sub>GS</sub> =-4.5V	--	5.5	--	nC
Q <sub>gs</sub>	Gate Source Charge		--	1.5	--	nC
Q <sub>gd</sub>	Gate Drain Charge		--	1.25	--	nC
t <sub>d(on)</sub>	Turn-on Delay Time		--	1350	--	nS
t <sub>r</sub>	Turn-on Rise Time	V <sub>DS</sub> =-6V, R <sub>L</sub> =6Ω, V <sub>GS</sub> =-4.5V, R <sub>G</sub> =6Ω	--	830	--	nS
t <sub>d(off)</sub>	Turn-Off Delay Time		--	5500	--	nS
t <sub>f</sub>	Turn-Off Fall Time		--	1500	--	nS

**Source-Drain Diode Characteristics**

V <sub>SD</sub>	Forward on voltage	T <sub>j</sub> =25°C, I <sub>S</sub> =-1.4A	--	--	-1.2	V
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### Typical Operating Characteristics

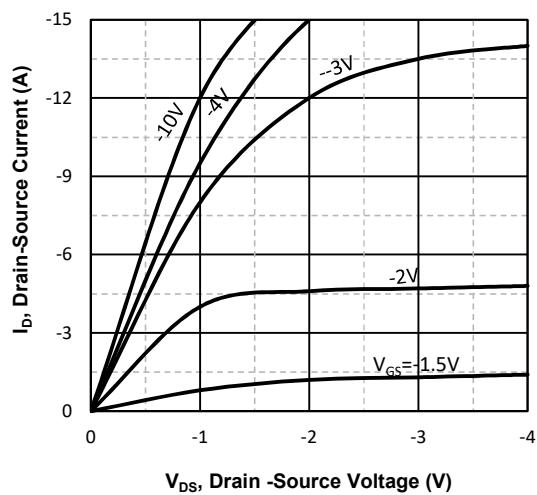


Fig1. Typical Output Characteristics

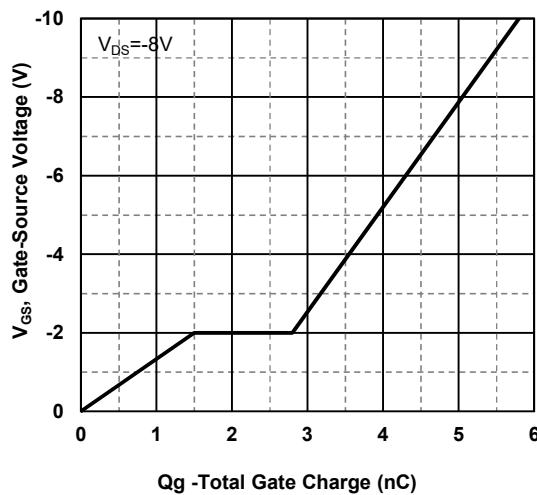


Fig2. Typical Gate Charge Vs.Gate-Source Voltage

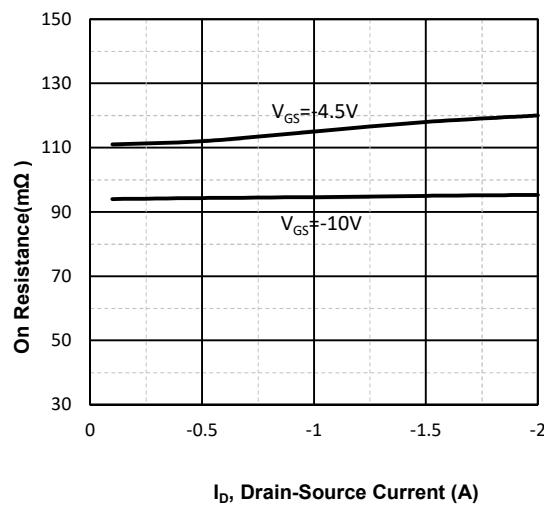


Fig3. Drain-Source on Resistance

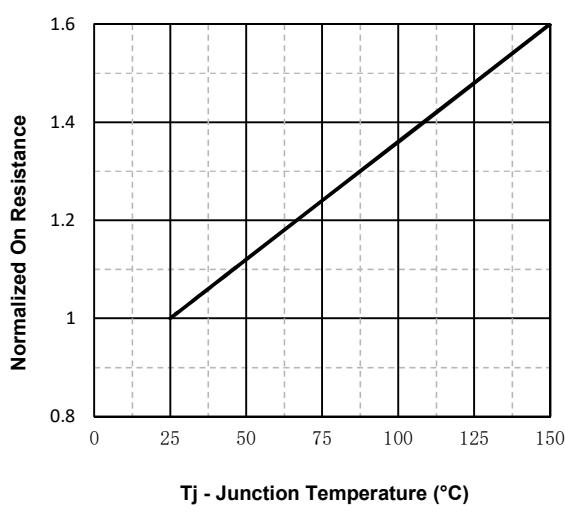


Fig4. Normalized On-Resistance Vs. Temperature

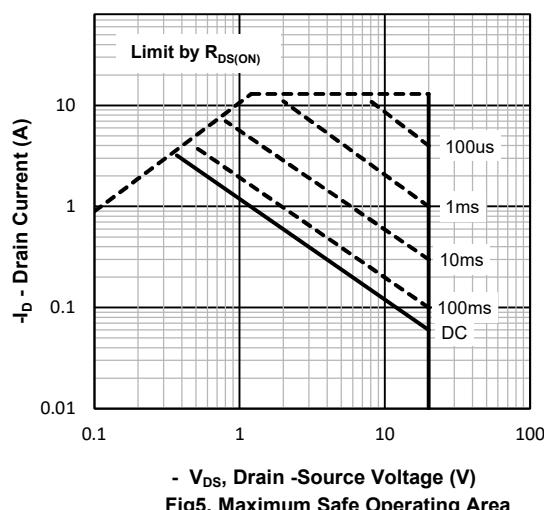


Fig5. Maximum Safe Operating Area

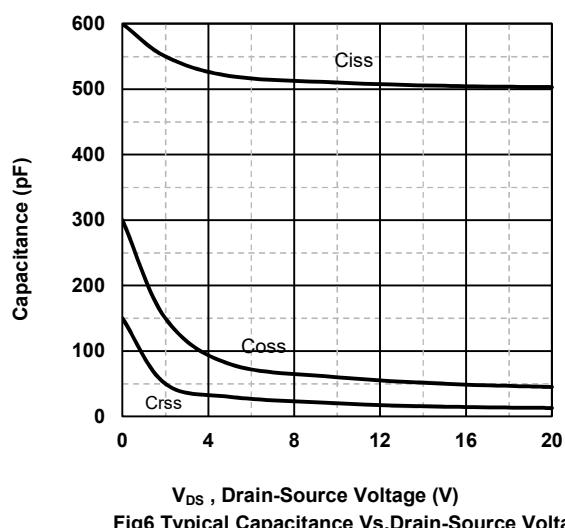
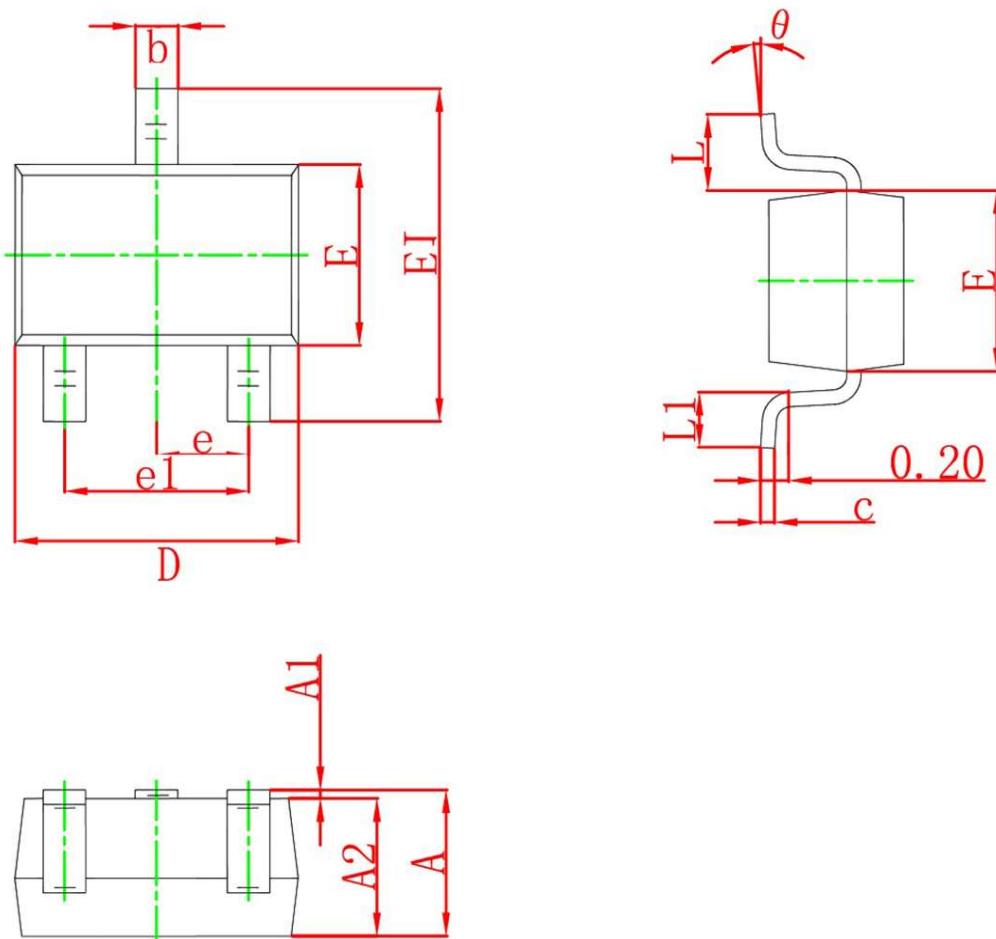


Fig6 Typical Capacitance Vs.Drain-Source Voltage

## SOT-323 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
<b>A</b>	0.900	1.100	0.035	0.043
<b>A1</b>	0.000	0.100	0.000	0.004
<b>A2</b>	0.900	1.000	0.035	0.039
<b>b</b>	0.200	0.400	0.008	0.016
<b>c</b>	0.080	0.150	0.003	0.006
<b>D</b>	2.000	2.200	0.079	0.087
<b>E</b>	1.150	1.350	0.045	0.053
<b>E1</b>	2.150	2.450	0.085	0.096
<b>e</b>	0.650TYP		0.026TYP	
<b>e1</b>	1.200	1.400	0.047	0.055
<b>L</b>	0.525REF		0.021REF	
<b>L1</b>	0.260	0.460	0.010	0.018
<b>θ</b>	0°	8°	0°	8°